

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Andrew Brian Thomas Hopkins</td> <td>07/15/2013</td> </tr> <tr> <td>Arnab Banerjee</td> <td>07/09/2013</td> </tr> <tr> <td>Stephen John Barlow</td> <td>07/12/2013</td> </tr> <tr> <td>Klaus Dieter McDonald-Maier</td> <td>07/15/2013</td> </tr> </tbody> </table>		Name	Execution Date	Andrew Brian Thomas Hopkins	07/15/2013	Arnab Banerjee	07/09/2013	Stephen John Barlow	07/12/2013	Klaus Dieter McDonald-Maier	07/15/2013
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Stephen John Barlow	07/12/2013										
Klaus Dieter McDonald-Maier	07/15/2013										
RECEIVING PARTY DATA											
Name:	UltraSoC Technologies Ltd.										
Street Address:	St John's Innovation Centre, Cowley Road										
City:	Cambridge										
State/Country:	UNITED KINGDOM										
Postal Code:	CB4 0WS										
PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13938098</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13938098						
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CORRESPONDENCE DATA											
Fax Number:	6507120263										
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>											
Phone:	650-712-0340										
Email:	motts@hmbay.com										
Correspondent Name:	HAYNES BEFFEL & WOLFELD LLP										
Address Line 1:	P O BOX 366										
Address Line 4:	HALF MOON BAY, CALIFORNIA 94019										
ATTORNEY DOCKET NUMBER:	USOC 1004-1										
NAME OF SUBMITTER:	Warren S. Wolfeld										
Signature:	/Warren S. Wolfeld/										

Date:

07/15/2013

**Total Attachments: 8**

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**JOINT TO CORPORATE ASSIGNMENT**

WHEREAS, the undersigned,

- (1) Andrew Brian Thomas HOPKINS  
Crossings Field, Woodland Road, Lyminge, Kent, CT18 8ET, United Kingdom
- (2) Arnab BANERJEE  
18 Mangers Lane, Dover, Kent, CT16 2QT, United Kingdom
- (3) Stephen John BARLOW  
Ambarvalia, High Street, Conington, Cambridge, CB23 4LT, United Kingdom
- (4) Klaus Dieter MCDONALD-MAIER  
147 Fronks Road, Harwich, Essex, CO12 4EE, United Kingdom

hereinafter termed "Inventors", have invented certain new and useful improvements in

**DEBUG ARCHITECTURE**

and

[ ] have filed a provisional application for a United States patent disclosing and identifying the above invention on , as Application No. ,

[X] have filed a non-provisional application for a United States patent disclosing and identifying the above invention on 9 July 2013, as U.S. Application No. ,

[ ] are filing a non-provisional application herewith, and

[X] have executed an oath or declaration of inventorship for such non-provisional application on:

- (1) the 15<sup>th</sup> day of July, 2013;
- (2) the \_\_\_\_\_ day of \_\_\_\_\_, 2013;
- (3) the \_\_\_\_\_ day of \_\_\_\_\_, 2013;
- (4) the \_\_\_\_\_ day of \_\_\_\_\_, 2013;

(hereinafter termed "applications"); and

WHEREAS, UltraSoC Technologies Ltd., a corporation of the United Kingdom, having a place of business at having a place of business at St John's Innovation Centre, Cowley Road, Cambridge, CB4 0WS, United Kingdom (hereinafter termed "Assignee"), is desirous of acquiring the entire right, title and interest in and to said applications and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered by said Inventors (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventors to have been received in full from said Assignee:

1. Said Inventors do hereby sell, assign, transfer and convey unto said Assignee the entire right, title and interest (a) in and to said applications and said invention; (b) in and to all rights to apply for foreign patents (including patent, utility model and

industrial design) on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise, including the right to claim priority from the applications; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a divisional, substitution, continuation, or continuation-in-part of any of said applications; and (d) in and to each and every reissue or extension of any of said patents.

2. Said Inventors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventors shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation reissues and reexaminations, opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventors in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventors, the Inventors' respective heirs, legal representatives and assigns.

4. Said Inventors hereby warrant and represent that said Inventors have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

5. Said Inventors hereby authorize any of the following attorneys:

Mark A. Haynes, Ernest J. Beffel, Jr., Warren S. Wolfeld, James F. Hann, Kenta Suzue, Alex Chou and Yiding Wu to (a) insert the date of execution of the oath or declaration of inventorship, and (b) insert the application number and filing date of this application when known.

IN WITNESS WHEREOF, said Inventors have executed and delivered this instrument to said Assignee as of the date written below.

A-B-7. Avels  
\_\_\_\_\_  
(1) Andrew Brian Thomas HOPKINS

Date: 15/07/2013

\_\_\_\_\_  
(2) Arnab BANERJEE

Date: \_\_\_\_\_

\_\_\_\_\_  
(3) Stephen John BARLOW

Date: \_\_\_\_\_

\_\_\_\_\_  
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Date: \_\_\_\_\_

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[ ] are filing a non-provisional application herewith, and

[X] have executed an oath or declaration of inventorship for such non-provisional application on:

- (1) the \_\_\_\_\_ day of \_\_\_\_\_, 2013;
- (2) the 9<sup>th</sup> day of July, 2013;
- (3) the \_\_\_\_\_ day of \_\_\_\_\_, 2013;
- (4) the \_\_\_\_\_ day of \_\_\_\_\_, 2013;

(hereinafter termed "applications"); and

WHEREAS, UltraSoC Technologies Ltd., a corporation of the United Kingdom, having a place of business at having a place of business at St John's Innovation Centre, Cowley Road, Cambridge, CB4 0WS, United Kingdom (hereinafter termed "Assignee"), is desirous of acquiring the entire right, title and interest in and to said applications and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered by said Inventors (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventors to have been received in full from said Assignee:

1. Said Inventors do hereby sell, assign, transfer and convey unto said Assignee the entire right, title and interest (a) in and to said applications and said invention; (b) in and to all rights to apply for foreign patents (including patent, utility model and

industrial design) on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise, including the right to claim priority from the applications; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a divisional, substitution, continuation, or continuation-in-part of any of said applications; and (d) in and to each and every reissue or extension of any of said patents.

2. Said Inventors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventors shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation reissues and reexaminations, opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventors in providing such cooperation shall be paid for by said Assignee.

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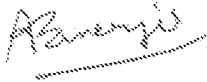
4. Said Inventors hereby warrant and represent that said Inventors have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

5. Said Inventors hereby authorize any of the following attorneys:

Mark A. Haynes, Ernest J. Beffel, Jr., Warren S. Wolfeld, James F. Hann, Kenta Suzue, Alex Chou and Yiding Wu to (a) insert the date of execution of the oath or declaration of inventorship, and (b) insert the application number and filing date of this application when known.

IN WITNESS WHEREOF, said Inventors have executed and delivered this instrument to said Assignee as of the date written below.

\_\_\_\_\_  
(1) Andrew Brian Thomas HOPKINS



Date: \_\_\_\_\_

9 July 2013

\_\_\_\_\_  
(2) Arnab BANERJEE

Date: \_\_\_\_\_

\_\_\_\_\_  
(3) Stephen John BARLOW

Date: \_\_\_\_\_ \

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(4) Klaus Dieter MCDONALD-MAIER

Date: \_\_\_\_\_

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[X] have executed an oath or declaration of inventorship for such non-provisional application on:

- (1) the \_\_\_\_\_ day of \_\_\_\_\_, 2013;
- (2) the \_\_\_\_\_ day of \_\_\_\_\_, 2013;
- (3) the 12<sup>th</sup> day of JULY, 2013;
- (4) the \_\_\_\_\_ day of \_\_\_\_\_, 2013;

(hereinafter termed "applications"); and

WHEREAS, UltraSoC Technologies Ltd., a corporation of the United Kingdom, having a place of business at having a place of business at St John's Innovation Centre, Cowley Road, Cambridge, CB4 0WS, United Kingdom (hereinafter termed "Assignee"), is desirous of acquiring the entire right, title and interest in and to said applications and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered by said Inventors (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

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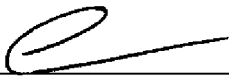
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\_\_\_\_\_  
(1) Andrew Brian Thomas HOPKINS

Date: \_\_\_\_\_

\_\_\_\_\_  
(2) Arnab BANERJEE

Date: \_\_\_\_\_

  
\_\_\_\_\_  
(3) Stephen John BARLOW

Date: 12 JULY 2013

\_\_\_\_\_  
(4) Klaus Dieter MCDONALD-MAIER

Date: \_\_\_\_\_



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- (1) Andrew Brian Thomas HOPKINS  
Crossings Field, Woodland Road, Lyminge, Kent, CT18 8ET, United Kingdom
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18 Mangers Lane, Dover, Kent, CT16 2QT, United Kingdom
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- (3) the \_\_\_\_\_ day of \_\_\_\_\_, 2013;
- (4) the 15th day of July, 2013;

(hereinafter termed "applications"); and

WHEREAS, UltraSoC Technologies Ltd., a corporation of the United Kingdom, having a place of business at having a place of business at St John's Innovation Centre, Cowley Road, Cambridge, CB4 0WS, United Kingdom (hereinafter termed "Assignee"), is desirous of acquiring the entire right, title and interest in and to said applications and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered by said Inventors (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

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Date: \_\_\_\_\_

  
\_\_\_\_\_  
(4) Klaus Dieter MCDONALD-MAJER

Date: 15 July 2013